

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): Sung Dae CHO
Assignee: Samsung Electronics Co., Ltd.
Title: Reel-Deployed Printed Circuit Board For Manufacturing Chip-On-Board Packages
Serial No.: Not Yet Assigned Filing Date: April 5, 2001
Examiner: Not Yet Assigned Group Art Unit: 1765
Docket No.: AB-698-1D US

Newport Beach, California
April 5, 2001

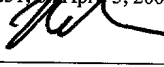
COMMISSIONER FOR PATENTS
Washington, D. C. 20231

PRELIMINARY AMENDMENT

Dear Sir:

Please cancel claims 10-20.

I hereby certify that this correspondence is being deposited with the United States Postal Service as Express Mail in an envelope addressed to: Commissioner for Patents, Washington, D.C. 20231, on April 5, 2001.

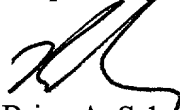


Attorney for Applicant(s)

April 5, 2001
Date of Signature

Express Mail No. EL661591824US

Respectfully submitted,


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